PIC16(L)F1717/1718/1719

PIC16(L)F1717/1718/1719 Family Silicon Errata and Data Sheet Clarification

The PIC16(L)F1717/1718/1719 family devices that you have received conform functionally to the current Device Data Sheet (DS40001740**B**), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in Table 1. The silicon issues are summarized in Table 2.

The errata described in this document will be addressed in future revisions of the PIC16(L)F1717/1718/1719 silicon.

Note:	This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of Table 2 apply to the current silicon revision **(A1)**.

Data Sheet clarifications and corrections start on page 5, following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB® IDE and Microchip's programmers, debuggers, and emulation tools, which are available at the Microchip corporate web site (www.microchip.com).

For example, to identify the silicon revision level using MPLAB IDE in conjunction with a hardware debugger:

1. Using the appropriate interface, connect the device to the hardware debugger.
2. Open an MPLAB IDE project.
3. Configure the MPLAB IDE project for the appropriate device and hardware debugger.
4. Based on the version of MPLAB IDE you are using, do one of the following:
   a) For MPLAB IDE 8, select *Programmer > Reconnect*.
   b) For MPLAB X IDE, select *Window > Dashboard* and click the **Refresh Debug Tool Status** icon ( ).
5. Depending on the development tool used, the part number *and* Device Revision ID value appear in the **Output** window.

Note:	If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The DEVREV values for the various PIC16(L)F1717/1718/1719 silicon revisions are shown in Table 1.

TABLE 1: SILICON DEVREV VALUES

Part Number	Device ID(1)	Revision ID (Silicon Revision)(2)	
		A0	A1
PIC16F1717	305Ch	2000h	2001h
PIC16LF1717	305Fh	2000h	2001h
PIC16F1718	305Bh	2000h	2001h
PIC16LF1718	305Eh	2000h	2001h
PIC16F1719	305Ah	2000h	2001h
PIC16LF1719	305Dh	2000h	2001h

Note 1: The Revision ID and Device ID are located in the Configuration memory at addresses 8005h and 8006h, respectively.

2: Refer to the *"PIC16(L)F171X Memory Programming Specification"* (DS40001714) for detailed information on Device and Revision IDs for your specific device.

TABLE 2: SILICON ISSUE SUMMARY

Module	Feature	Item Number	Issue Summary	Affected Revision(1)	
				A0	A1
Comparator	Low-Power Mode	1.1	Unexpected Low-Power mode performance.	X	X
Fixed Voltage Reference (FVR)	4x Gain Amplifier	2.1	The output of the 4x gain amplifier is 4.25V.	X	X
COG	Blanking	3.1	Blanking may fail to release.	X	—
EUSART	Transmit	4.1	Duplicate Transmission.	X	—
Master Synchronous Serial Port (MSSP)	SPI Slave Mode	5.1	Slave select release during Sleep corrupts data.	X	—
Master Synchronous Serial Port (MSSP)	SPI Slave Mode	5.2	Receive data lost when Slave select enable occurs just before Sleep execution.	X	—
Master Synchronous Serial Port (MSSP)	SPI Slave Mode	5.3	WCOL improperly set in Sleep.	X	—

Note 1: Only those issues indicated in the last column apply to the current silicon revision.

Silicon Errata Issues

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision **(A1)**.

1. Module: Comparator

1.1 Low-Power Mode

Unexpected performance may result when operating the comparator in Low-Power, Low-Speed mode (CxSP = 0).

Work around

Use the comparator in High-Speed, High-Power mode (CxSP = 1).

Affected Silicon Revisions

A0	A1						
X	X						

2. Module: Fixed Voltage Reference (FVR)

2.1 4x Gain Amplifier

The output of the 4x gain amplifier is 4.25V ±6%.

Work around

None.

Affected Silicon Revisions

A0	A1						
X	X						

3. Module: COG

3.1 Input Blanking May Not Release

When level mode input sensitivity is selected, input blanking is not zero, and a rising event occurs simultaneously with a falling event, then the blanking circuit that inhibits falling events will remain in the blanking state and the COG output will remain in the active state until a shutdown event or COG module Reset.

Work around

Use edge sensitivity or set blanking times to zero.

Affected Silicon Revisions

A0	A1						
X							

4. Module: EUSART

4.1 Duplicate Transmission

Under certain conditions, a byte written to the TXREG register can be transmitted twice. This happens when a byte is written to TXREG just as the TSR register becomes empty. This new byte is immediately transferred to the TSR register, but also remains in the TXREG register until the completion of the current instruction cycle. If the new byte in the TSR register is transmitted before this instruction cycle has completed, the duplicate in the TXREG register will subsequently be transferred to the TSR register on the following instruction clock cycle and transmitted.

Work around

1. Monitor the Transmit Interrupt Flag bit (TXIF). Writes to the TXREG register can be performed once the TXIF bit is set, indicating that the TXREG register is empty.
2. Monitor the TMRT bit of the TXxSTA register. Writes to the TXREG register can be performed once the TMRT bit is set, indicating that the Transmit Shift Register (TSR) is empty.

Affected Silicon Revisions

A0	A1						
X							

5. Module: Master Synchronous Serial Port (MSSP)

5.1 SPI Slave Data Corruption During Sleep

When the MSSP module is configured in SPI Slave mode with $\overline{SS}$ pin control enabled (SSPM = 0100) and the device is in Sleep mode during SPI activity, if the SPI master releases the $\overline{SS}$ line ($\overline{SS}$ goes high) before the device wakes from Sleep and updates SSPBUF, the received data will be lost.

Work around

Method 1: The SPI master must wait a minimum of parameter SP83 (1.5 TCY + 40 nS) after the last SCK edge AND the additional wake-up time from Sleep (device dependent) before releasing the $\overline{SS}$ line.

Method 2: If both the Master and Slave devices have an available pin, once the Slave has completed the transaction and BF or SSPIF is set, the slave could toggle an output to inform the Master that the transaction is complete and that it is safe to release the $\overline{SS}$ line.

Affected Silicon Revisions

A0	A1						
X							

5.2 SPI Slave Data Lost Before Sleep Execution

When the MSSP module is configured in SPI Slave mode with $\overline{SS}$ pin control enabled (SSPM = 0100) and the device is in Sleep mode during SPI activity, if the SPI Master enables $\overline{SS}$ ($\overline{SS}$ goes low) within 1 TCY before Sleep is executed, the data written into the SSPBUF by the slave for transmission will remain in the SSPBUF, and the byte received by the slave will be completely discarded. The MSb of the data byte that is currently loaded into SSPBUF will be transmitted on each of the eight SCK clocks, resulting in either a 0x00 or 0xFF to be incorrectly transmitted. This issue typically occurs when the device wakes up from Sleep to process data and immediately goes back to Sleep during the next transmission.

Work around

The SPI Slave must wait a minimum of 2.25 * TCY from the time the $\overline{SS}$ line becomes active ($\overline{SS}$ goes low) before executing the Sleep command.

Affected Silicon Revisions

A0	A1						
X							

5.3 WCOL Bit Improperly Set During Sleep

When the MSSP module is configured with either of the Slave modes listed below and Sleep is executed during transmission, the WCOL bit is erroneously set. Although the WCOL bit is set, it does not cause a break in transmission or reception.

Mode 1: SPI Slave mode with $\overline{SS}$ disabled (SSPM = 0101) and CKE = 0.

Mode 2: SPI Slave mode with $\overline{SS}$ enabled (SSPM = 0100) and $\overline{SS}$ in not set and then cleared before each consecutive transmission. This typically occurs during multiple byte transmissions in which the Master does not release the $\overline{SS}$ line until all transmission has completed.

Work around

Method 1: The WCOL bit can be ignored since the issue does not interfere with MSSP hardware.

Method 2: Clear the SSPEN after each transaction, then set SSPEN before the next transaction.

Affected Silicon Revisions

A0	A1						
X							

Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS40001740**B**):

Note:	Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

None.

APPENDIX A: DOCUMENT REVISION HISTORY

Rev A Document (04/2015)

Initial release of this document.

Rev B Document (10/2015)

Changed Silicon revision A1 to A0; Other minor corrections.

Rev C Document (3/2016)

Added Silicon revision A1; Other minor corrections.

Rev D Document (6/2017)

Updated the Work around section of Module 4, EUSART.

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.

QUALITY MANAGEMENT SYSTEM
CERTIFIED BY DNV
═ ISO/TS 16949 ═

Trademarks

ISBN: 978-1-5224-1841-2

Worldwide Sales and Service

AMERICAS

Corporate Office
2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-792-7200
Fax: 480-792-7277
Technical Support:
http://www.microchip.com/support
Web Address:
www.microchip.com

Atlanta
Duluth, GA
Tel: 678-957-9614
Fax: 678-957-1455

Austin, TX
Tel: 512-257-3370

Boston
Westborough, MA
Tel: 774-760-0087
Fax: 774-760-0088

Chicago
Itasca, IL
Tel: 630-285-0071
Fax: 630-285-0075

Dallas
Addison, TX
Tel: 972-818-7423
Fax: 972-818-2924

Detroit
Novi, MI
Tel: 248-848-4000

Houston, TX
Tel: 281-894-5983

Indianapolis
Noblesville, IN
Tel: 317-773-8323
Fax: 317-773-5453
Tel: 317-536-2380

Los Angeles
Mission Viejo, CA
Tel: 949-462-9523
Fax: 949-462-9608
Tel: 951-273-7800

Raleigh, NC
Tel: 919-844-7510

New York, NY
Tel: 631-435-6000

San Jose, CA
Tel: 408-735-9110
Tel: 408-436-4270

Canada - Toronto
Tel: 905-695-1980
Fax: 905-695-2078

ASIA/PACIFIC

Asia Pacific Office
Suites 3707-14, 37th Floor
Tower 6, The Gateway
Harbour City, Kowloon

Hong Kong
Tel: 852-2943-5100
Fax: 852-2401-3431

Australia - Sydney
Tel: 61-2-9868-6733
Fax: 61-2-9868-6755

China - Beijing
Tel: 86-10-8569-7000
Fax: 86-10-8528-2104

China - Chengdu
Tel: 86-28-8665-5511
Fax: 86-28-8665-7889

China - Chongqing
Tel: 86-23-8980-9588
Fax: 86-23-8980-9500

China - Dongguan
Tel: 86-769-8702-9880

China - Guangzhou
Tel: 86-20-8755-8029

China - Hangzhou
Tel: 86-571-8792-8115
Fax: 86-571-8792-8116

China - Hong Kong SAR
Tel: 852-2943-5100
Fax: 852-2401-3431

China - Nanjing
Tel: 86-25-8473-2460
Fax: 86-25-8473-2470

China - Qingdao
Tel: 86-532-8502-7355
Fax: 86-532-8502-7205

China - Shanghai
Tel: 86-21-3326-8000
Fax: 86-21-3326-8021

China - Shenyang
Tel: 86-24-2334-2829
Fax: 86-24-2334-2393

China - Shenzhen
Tel: 86-755-8864-2200
Fax: 86-755-8203-1760

China - Wuhan
Tel: 86-27-5980-5300
Fax: 86-27-5980-5118

China - Xian
Tel: 86-29-8833-7252
Fax: 86-29-8833-7256

ASIA/PACIFIC

China - Xiamen
Tel: 86-592-2388138
Fax: 86-592-2388130

China - Zhuhai
Tel: 86-756-3210040
Fax: 86-756-3210049

India - Bangalore
Tel: 91-80-3090-4444
Fax: 91-80-3090-4123

India - New Delhi
Tel: 91-11-4160-8631
Fax: 91-11-4160-8632

India - Pune
Tel: 91-20-3019-1500

Japan - Osaka
Tel: 81-6-6152-7160
Fax: 81-6-6152-9310

Japan - Tokyo
Tel: 81-3-6880- 3770
Fax: 81-3-6880-3771

Korea - Daegu
Tel: 82-53-744-4301
Fax: 82-53-744-4302

Korea - Seoul
Tel: 82-2-554-7200
Fax: 82-2-558-5932 or
82-2-558-5934

Malaysia - Kuala Lumpur
Tel: 60-3-6201-9857
Fax: 60-3-6201-9859

Malaysia - Penang
Tel: 60-4-227-8870
Fax: 60-4-227-4068

Philippines - Manila
Tel: 63-2-634-9065
Fax: 63-2-634-9069

Singapore
Tel: 65-6334-8870
Fax: 65-6334-8850

Taiwan - Hsin Chu
Tel: 886-3-5778-366
Fax: 886-3-5770-955

Taiwan - Kaohsiung
Tel: 886-7-213-7830

Taiwan - Taipei
Tel: 886-2-2508-8600
Fax: 886-2-2508-0102

Thailand - Bangkok
Tel: 66-2-694-1351
Fax: 66-2-694-1350

EUROPE

Austria - Wels
Tel: 43-7242-2244-39
Fax: 43-7242-2244-393

Denmark - Copenhagen
Tel: 45-4450-2828
Fax: 45-4485-2829

Finland - Espoo
Tel: 358-9-4520-820

France - Paris
Tel: 33-1-69-53-63-20
Fax: 33-1-69-30-90-79

France - Saint Cloud
Tel: 33-1-30-60-70-00

Germany - Garching
Tel: 49-8931-9700

Germany - Haan
Tel: 49-2129-3766400

Germany - Heilbronn
Tel: 49-7131-67-3636

Germany - Karlsruhe
Tel: 49-721-625370

Germany - Munich
Tel: 49-89-627-144-0
Fax: 49-89-627-144-44

Germany - Rosenheim
Tel: 49-8031-354-560

Israel - Ra'anana
Tel: 972-9-744-7705

Italy - Milan
Tel: 39-0331-742611
Fax: 39-0331-466781

Italy - Padova
Tel: 39-049-7625286

Netherlands - Drunen
Tel: 31-416-690399
Fax: 31-416-690340

Norway - Trondheim
Tel: 47-7289-7561

Poland - Warsaw
Tel: 48-22-3325737

Romania - Bucharest
Tel: 40-21-407-87-50

Spain - Madrid
Tel: 34-91-708-08-90
Fax: 34-91-708-08-91

Sweden - Gothenberg
Tel: 46-31-704-60-40

Sweden - Stockholm
Tel: 46-8-5090-4654

UK - Wokingham
Tel: 44-118-921-5800
Fax: 44-118-921-5820